

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

**TC74VHCT540AF,TC74VHCT540AFW,TC74VHCT540AFT,TC74VHCT540AFK  
TC74VHCT541AF,TC74VHCT541AFW,TC74VHCT541AFT,TC74VHCT541AFK****Octal Bus Buffer**TC74VHCT540AF/AFW/AFT/AFK  
Inverted, 3-State OutputsTC74VHCT541AF/AFW/AFT/AFK  
Non-Inverted, 3-State Outputs

The TC74VHCT540A and 541A are advanced high speed CMOS OCTAL BUS BUFFERs fabricated with silicon gate C<sup>2</sup>MOS technology. They achieve the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

The TC74VHCT540A is an inverting type and, the TC74VHCT541A is a non-inverting type.

When either G<sub>1</sub> or G<sub>2</sub> are high, the terminal outputs are in the high-impedance state.

The input voltage are compatible with TTL output voltage. These devices may be used as a level converter for interfacing 3.3 V to 5 V system.

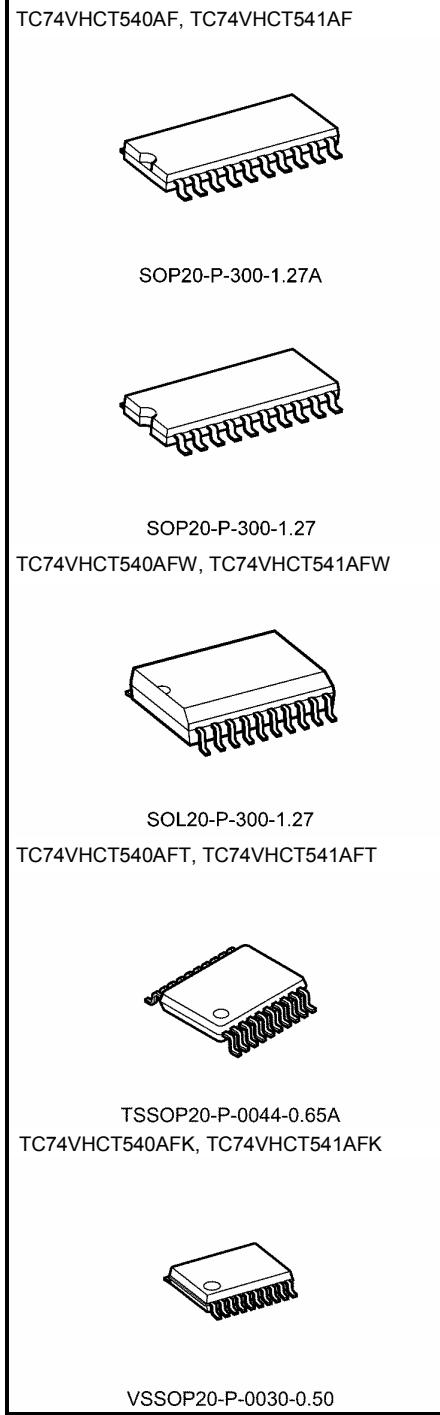
Input protection and output circuit ensure that 0 to 5.5 V can be applied to the input and output (Note) pins without regard to the supply voltage. These structure prevents device destruction due to mismatched supply and input/output voltages such as battery back up, hot board insertion, etc.

Note: Output in off-state

**Features**

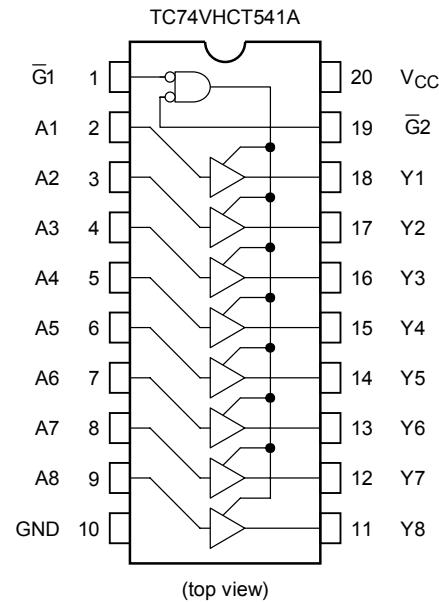
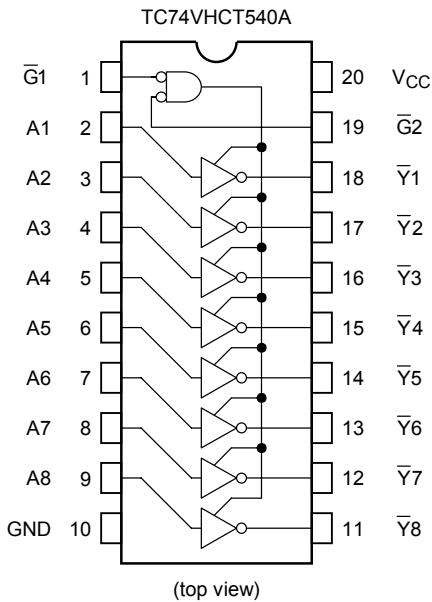
- High speed: t<sub>pd</sub> = 5.4 ns (typ.) at V<sub>CC</sub> = 5 V
- Low power dissipation: I<sub>CC</sub> = 4 μA (max) at Ta = 25°C
- Compatible with TTL outputs: V<sub>IL</sub> = 0.8 V (max)  
V<sub>IH</sub> = 2.0 V (min)
- Power down protection is provided on all inputs and outputs
- Balanced propagation delays: t<sub>pLH</sub> ≈ t<sub>pHL</sub>
- Low noise: VOLP = 1.6 V (max)
- Pin and function compatible with the 74 series  
(74AC/HC/F/ALS/LS etc.) 540/541 type.

Note: xxxFW (JEDEC SOP) is not available in Japan.

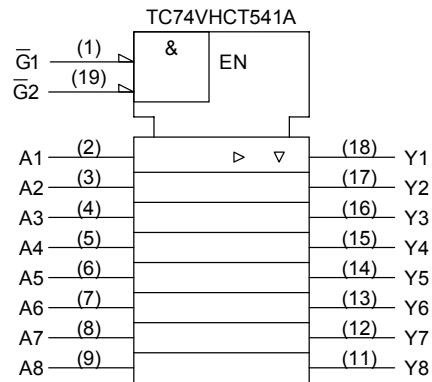
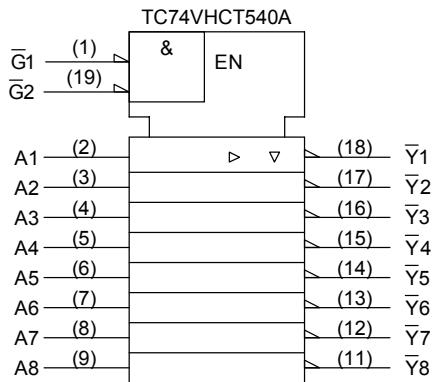
**Weight**

SOP20-P-300-1.27A	: 0.22 g (typ.)
SOP20-P-300-1.27	: 0.22 g (typ.)
SOL20-P-300-1.27	: 0.46 g (typ.)
TSSOP20-P-0044-0.65A	: 0.08 g (typ.)
VSSOP20-P-0030-0.50	: 0.03 g (typ.)

## Pin Assignment



## IEC Logic Symbol



## Truth Table

Inputs			Outputs	
$\bar{G}_1$	$\bar{G}_2$	A <sub>n</sub>	Y <sub>n</sub>	$\bar{Y}_n$
H	X	X	Z	Z
X	H	X	Z	Z
L	L	H	H	L
L	L	L	L	H

X: Don't care

Z: High impedance

Y<sub>n</sub>: VHCT541A

$\bar{Y}_n$  : VHCT540A

**Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	-0.5 to 7.0	V
DC input voltage	V <sub>IN</sub>	-0.5 to 7.0	V
DC output voltage	V <sub>OUT</sub>	-0.5 to 7.0 (Note 2)	V
		-0.5 to V <sub>CC</sub> + 0.5 (Note 3)	
Input diode current	I <sub>IK</sub>	-20	mA
Output diode current	I <sub>OK</sub>	±20 (Note 4)	mA
DC output current	I <sub>OUT</sub>	±25	mA
DC V <sub>CC</sub> /ground current	I <sub>CC</sub>	±75	mA
Power dissipation	P <sub>D</sub>	180	mW
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Note 2: Output in off-state

Note 3: High or low state. I<sub>OUT</sub> absolute maximum rating must be observed.

Note 4: V<sub>OUT</sub> < GND, V<sub>OUT</sub> > V<sub>CC</sub>

**Recommended Operating Conditions (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	4.5 to 5.5	V
Input voltage	V <sub>IN</sub>	0 to 5.5	V
Output voltage	V <sub>OUT</sub>	0 to 5.5 (Note 2)	V
		0 to V <sub>CC</sub> (Note 3)	
Operating temperature	T <sub>opr</sub>	-40 to 85	°C
Input rise and fall time	d <sub>t</sub> /dV	0 to 20	ns/V

Note 1: The recommended operating conditions are required to ensure the normal operation of the device.  
Unused inputs must be tied to either V<sub>CC</sub> or GND.

Note 2: Output in off-state

Note 3: High or low state

**Electrical Characteristics****DC Characteristics**

Characteristics	Symbol	Test Condition		V <sub>CC</sub> (V)	Ta = 25°C			Ta = -40 to 85°C		Unit
					Min	Typ.	Max	Min	Max	
High-level input voltage	V <sub>IH</sub>	—		4.5 to 5.5	2.0	—	—	2.0	—	V
Low-level input voltage	V <sub>IL</sub>	—		4.5 to 5.5	—	—	0.8	—	0.8	V
High-level output voltage	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -50 µA	4.5	4.40	4.50	—	4.40	—	V
			I <sub>OH</sub> = -8 mA	4.5	3.94	—	—	3.80	—	
Low-level output voltage	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 50 µA	4.5	—	0.0	0.10	—	0.10	V
			I <sub>OL</sub> = 8 mA	4.5	—	—	0.36	—	0.44	
3-state output off-state current	I <sub>OZ</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>OUT</sub> = V <sub>CC</sub> or GND		5.5	—	—	±0.25	—	±2.50	µA
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND		0 to 5.5	—	—	±0.1	—	±1.0	µA
Quiescent supply current	I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	—	—	4.0	—	40.0	µA
	I <sub>CCT</sub>	Per input: V <sub>IN</sub> = 3.4 V Other input: V <sub>CC</sub> or GND		5.5	—	—	1.35	—	1.50	mA
Output leakage current	I <sub>OPD</sub>	V <sub>OUT</sub> = 5.5 V		0	—	—	+0.5	—	+5.0	µA

**AC Characteristics (input: t<sub>r</sub> = t<sub>f</sub> = 3 ns)**

Characteristics	Symbol	Test Condition		V <sub>CC</sub> (V)	Ta = 25°C			Ta = -40 to 85°C		Unit	
					C <sub>L</sub> (pF)	Min	Typ.	Max	Min		
Propagation delay time (TC74VHCT540A)	t <sub>pLH</sub>	—	5.0 ± 0.5	15	—	5.4	7.4	1.0	8.5	ns	
	t <sub>pHL</sub>			50	—	5.9	8.4	1.0	9.5		
Propagation delay time (TC74VHCT541A)	t <sub>pLH</sub>	—	5.0 ± 0.5	15	—	5.0	6.9	1.0	8.0	ns	
	t <sub>pHL</sub>			50	—	5.5	7.9	1.0	9.0		
3-state output enable time	t <sub>pZL</sub>	R <sub>L</sub> = 1 kΩ	5.0 ± 0.5	15	—	8.3	11.3	1.0	13.0	ns	
	t <sub>pZH</sub>			50	—	8.8	12.3	1.0	14.0		
3-state output disable time	t <sub>pLZ</sub>	R <sub>L</sub> = 1 kΩ	5.0 ± 0.5	50	—	9.4	11.9	1.0	13.5	ns	
Output to output skew	t <sub>osLH</sub>			(Note 1)	5.0 ± 0.5	50	—	1.0	—	1.0	
Input capacitance	C <sub>IN</sub>	—			—	4	10	—	10	pF	
Output capacitance	C <sub>OUT</sub>	—			—	9	—	—	—	pF	
Power dissipation capacitance	C <sub>PD</sub>	(Note 2)			—	19	—	—	—	pF	

Note 1: Parameter guaranteed by design.

$$t_{osLH} = |t_{pLHm} - t_{pLHn}|, t_{osHL} = |t_{pHLM} - t_{pHLn}|$$

Note 2: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$I_{CC (\text{opr})} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per bit)}$$

**Noise Characteristics (input:  $t_r = t_f = 3 \text{ ns}$ ) (Note)**

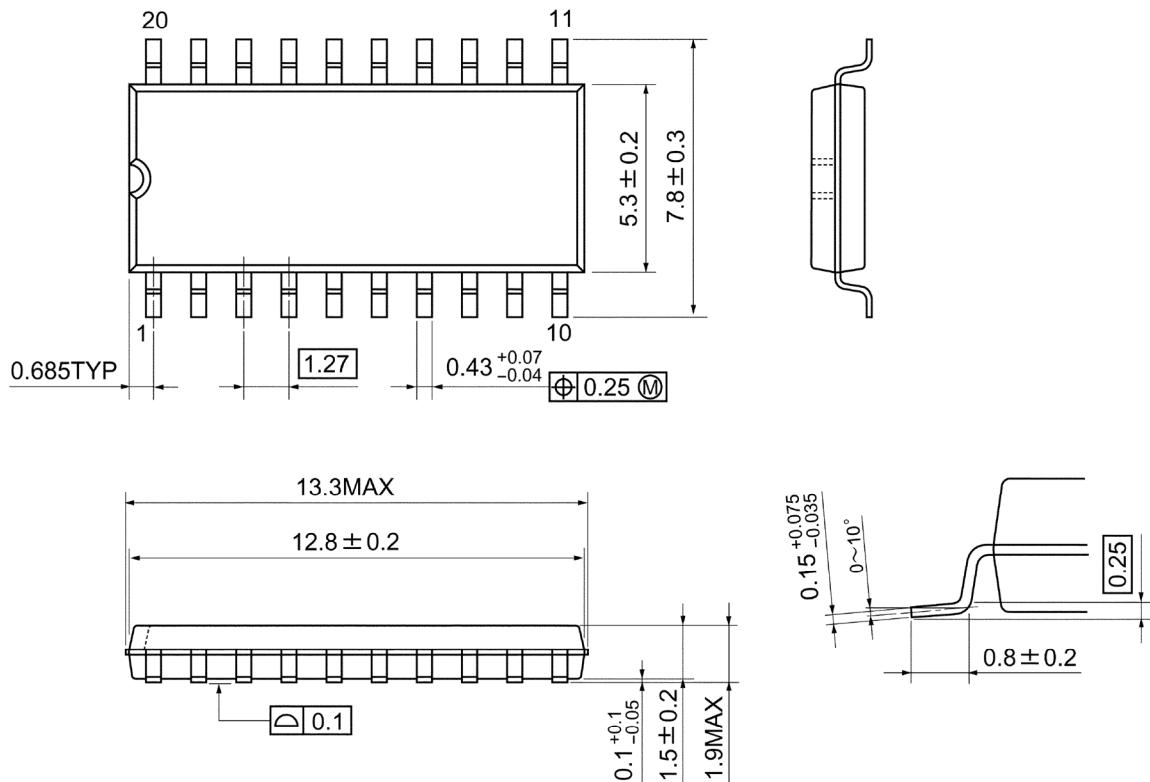
Characteristics	Symbol	Test Condition	$V_{CC} (\text{V})$	Ta = 25°C		Unit
				Typ.	Limit	
Quiet output maximum dynamic $V_{OL}$	$V_{OLP}$	$C_L = 50 \text{ pF}$	5.0	1.1 (1.2)	1.5 (1.6)	V
Quiet output minimum dynamic $V_{OL}$	$V_{OLV}$	$C_L = 50 \text{ pF}$	5.0	-1.1 (-1.2)	-1.5 (-1.6)	V
Minimum high level dynamic input voltage	$V_{IHD}$	$C_L = 50 \text{ pF}$	5.0	—	2.0	V
Maximum low level dynamic input voltage	$V_{ILD}$	$C_L = 50 \text{ pF}$	5.0	—	0.8	V

Note: The value in ( ) only applies to JEDEC SOP (FW) devices.

**Package Dimensions**

SOP20-P-300-1.27A

Unit: mm

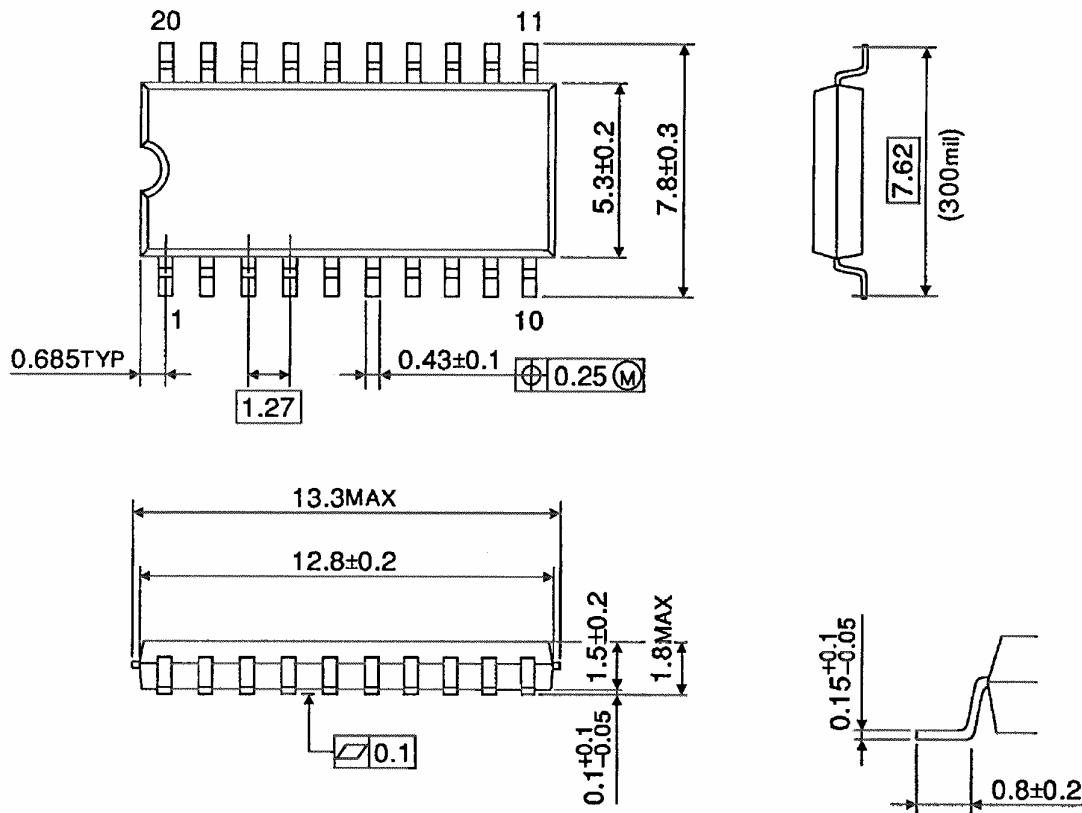


Weight: 0.22 g (typ.)

**Package Dimensions**

SOP20-P-300-1.27

Unit : mm

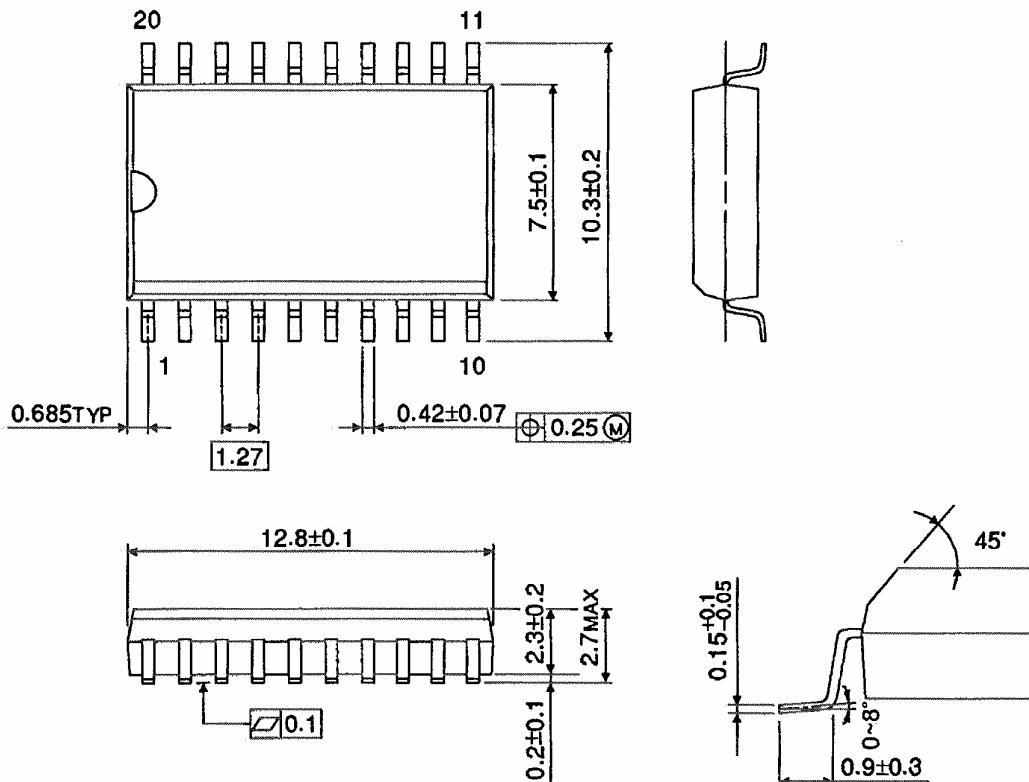


Weight: 0.22 g (typ.)

**Package Dimensions (Note)**

SOL20-P-300-1.27

Unit : mm



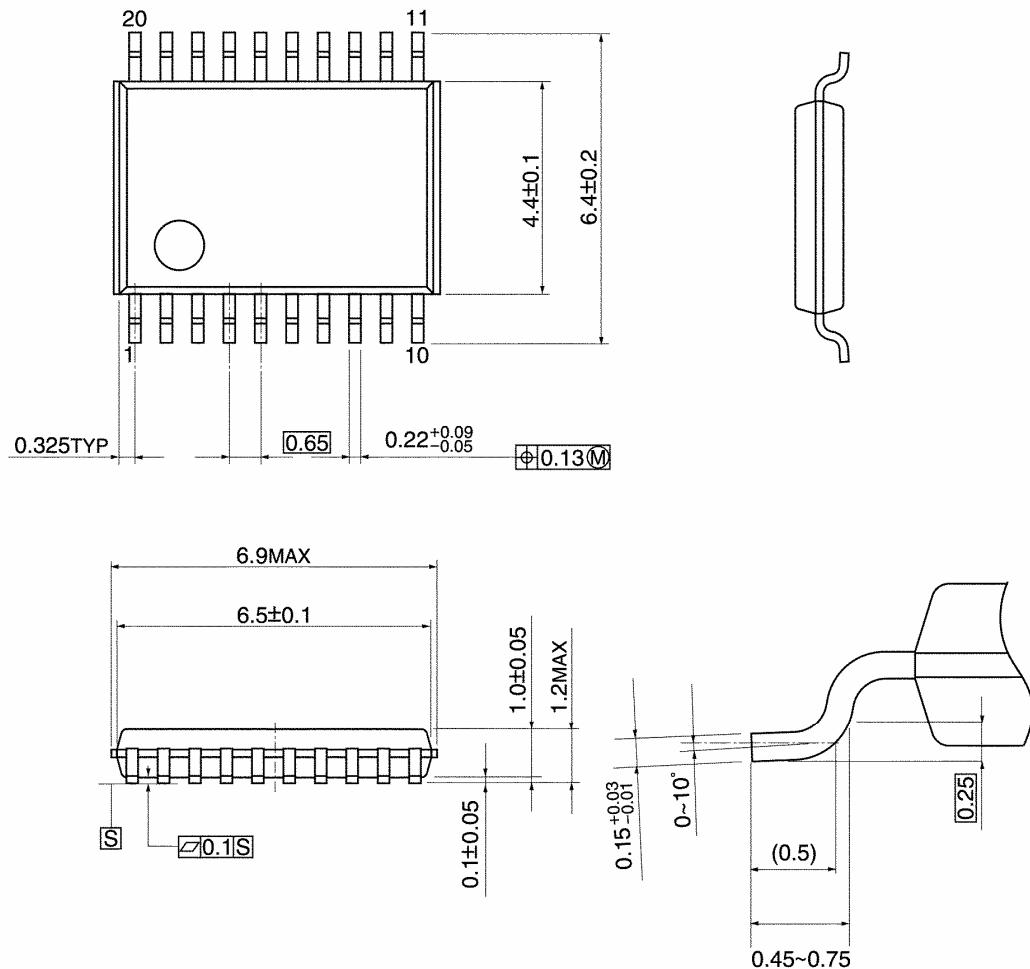
Note: This package is not available in Japan.

Weight: 0.46 g (typ.)

**Package Dimensions**

TSSOP20-P-0044-0.65A

Unit: mm

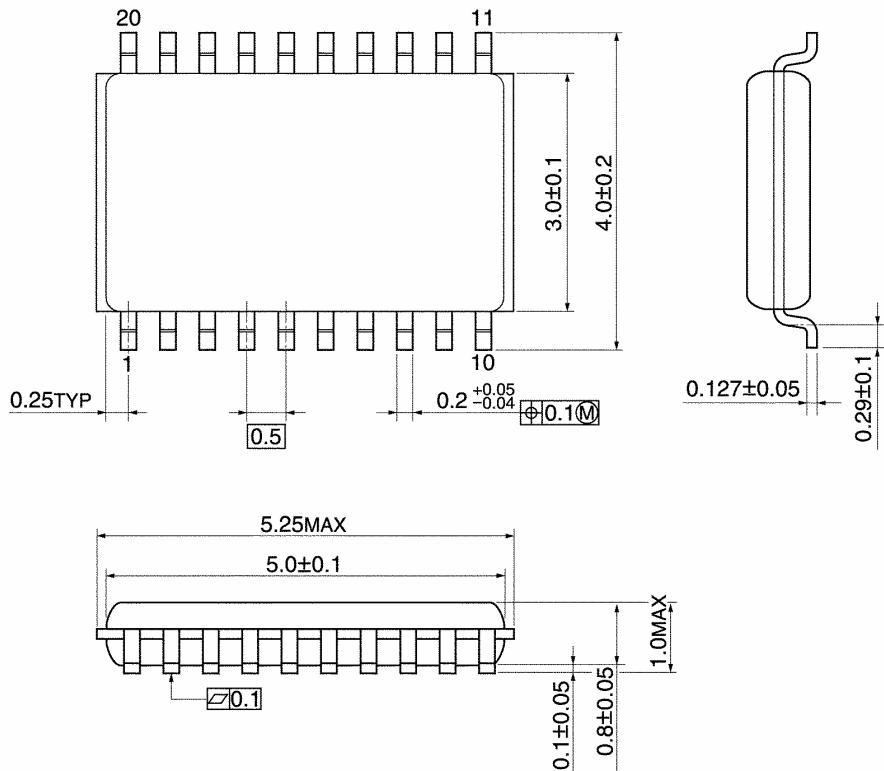


Weight: 0.08 g (typ.)

**Package Dimensions**

VSSOP20-P-0030-0.50

Unit: mm



Weight: 0.03 g (typ.)

**Note: Lead (Pb)-Free Packages****SOP20-P-300-1.27A TSSOP20-P-0044-0.65A VSSOP20-P-0030-0.50****RESTRICTIONS ON PRODUCT USE**

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